MOSFET – N-Channel, SUPREMOS, FRFET

600 V, 72.8 A, 38 mΩ

FCH76N60NF

Description

The SUPREMOS[®] MOSFET is ON Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SUPREMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPREMOS FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- $R_{DS(on)} = 28.7 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$
- Ultra Low Gate Charge (Typ. Q_g = 230 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 896 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

Applications

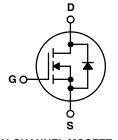
- Solar Inverter
- AC-DC Power Supply



ON Semiconductor®

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V _{DS}	V _{DS} R _{DS(ON)} MAX	
600 V	38 mΩ @ 10 V	72.8 A

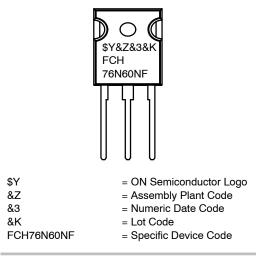


N-CHANNEL MOSFET



CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FCH76N60NF

600

±30

Unit

V V

Symbol		Parameter		
V_{DSS}	Drain to Source Voltage			
V_{GSS}	Gate to Source Voltage			
Ι _D	Drain Current	– Continuous (T _C = 25°C)		

MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

I _D	Drain Current	– Continuous (T _C = 25°C)	72.8	Α
		– Continuous (T _C = 100°C)	46	1
I _{DM}	Drain Current	– Pulsed (Note 1)	218	А
E _{AS}	Single Pulsed Avalanche Energy (Note	2)	7381	mJ
I _{AR}	Avalanche Current (Note 1)		24.3	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		5.43	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	1
PD	Power Dissipation	$(T_C = 25^{\circ}C)$	543	W
		– Derate above 25°C	4.34	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		–55 to + 150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 24.3 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25 ^{\circ}C$ 3. $I_{SD} \leq 72.8 \text{ A}$, di/dt $\leq 1200 \text{ A/}\mu$ s, $V_{DD} \leq 380 \text{ V}$, starting $T_J = 25 ^{\circ}C$

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH76N60NF	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.23	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FCH76N60NF	FCH76N60NF	TO-247-3LD	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS	•				
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$	600	-	_	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C	-	0.73	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 480 V, V_{GS} = 0 V	-	-	10	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125°C	-	-	100	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ± 30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS	-				-
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS},\ I_{D}=250\ \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 38 A	-	28.7	38.0	mΩ
9FS	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 38 \text{ A}$	-	92	-	S
DYNAMIC C	HARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V},$	_	8305	11045	pF
C _{oss}	Output Capacitance	f = 1 MHz	_	361	480	pF
C _{rss}	Reverse Transfer Capacitance		-	3.3	5.0	pF
C _{oss}	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	-	192	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 380 V, V_{GS} = 0 V	-	896	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A},$	-	230	300	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10 V (Note 4)	_	44	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	_	95	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1 MHz	-	1.2	-	Ω
SWITCHING	CHARACTERISTICS	-				-
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A},$	-	51	112	ns
t _r	Turn–On Rise Time	R _G = 4.7 Ω (Note 4)	_	44	98	ns
t _{d(off)}	Turn-Off Delay Time		_	213	436	ns
t _f	Turn–Off Fall Time	1	_	43	96	ns
DRAIN-SOU	RCE DIODE CHARACTERISTICS	·				-
۱ _S	Maximum Continuous Drain to Source D	iode Forward Current	-	-	76	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	228	Α
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 38 \text{ A}$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 38 A,$	_	200	_	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/µs	_	1.8	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially Independent of Operating Temperature Typical Characteristics.

TYPICAL CHARACTERISTICS

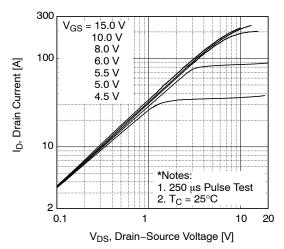


Figure 1. On–Region Characteristics

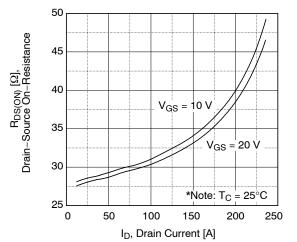


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

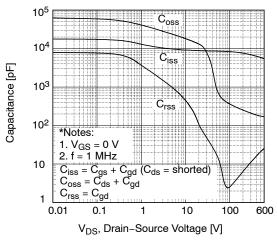


Figure 5. Capacitance Characteristics

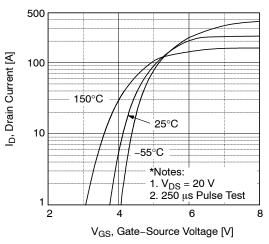


Figure 2. Transfer Characteristics

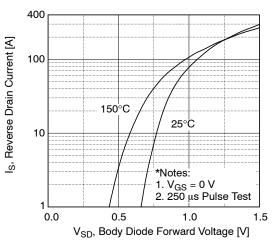
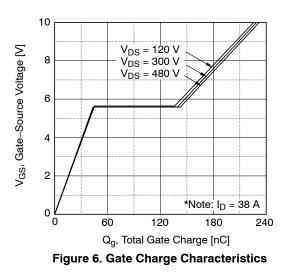
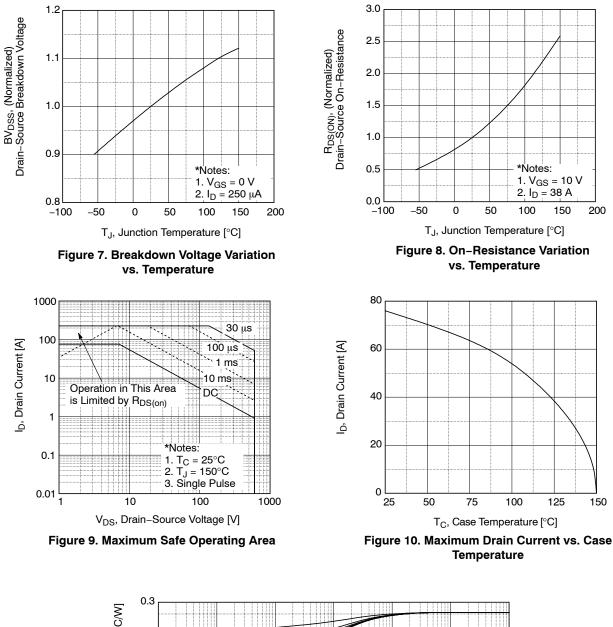


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL CHARACTERISTICS (continued)



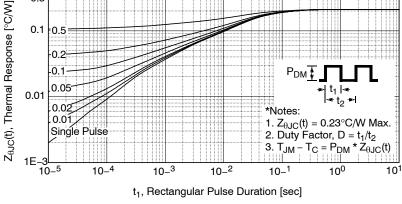


Figure 11. Transient Thermal Response Curve

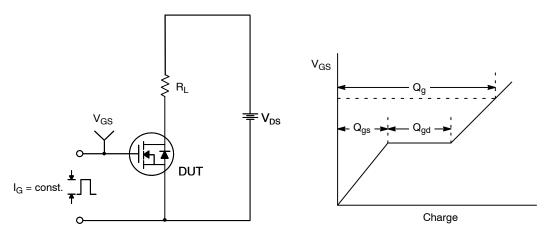


Figure 12. Gate Charge Test Circuit & Waveform

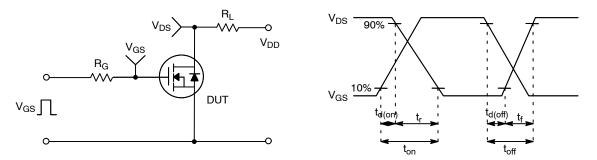


Figure 13. Resistive Switching Test Circuit & Waveforms

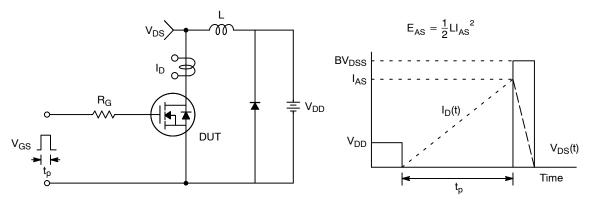


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

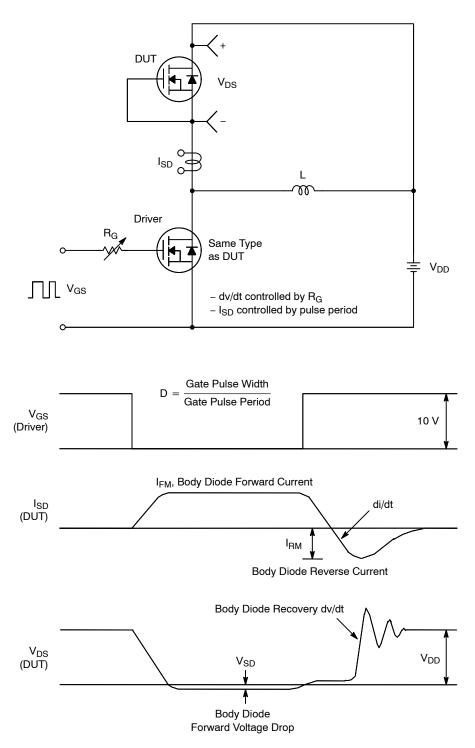


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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